# Si4166DY

RoHS

COMPLIANT

HALOGEN

FREE

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PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.0039				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_GS$ = 4.5 V	0.0055				
Q <sub>g</sub> typ. (nC)	21.5				
I <sub>D</sub> (A) <sup>a</sup>	30.5				
Configuration	Single				

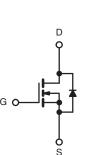
#### FEATURES

N-Channel 30 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

#### **APPLICATIONS**

- Low side DC/DC conversion
  Notebook PC
- Gaming



N-Channel MOSFET

## ORDERING INFORMATION

Package	SO-8
Lead (Pb)-free and halogen-free	Si4166DY-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	N/	
Gate-source voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		30.5		
Continuous drain surrant (T 150 °C)	T <sub>C</sub> = 70 °C	1 , Г	24.5		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C		20.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		16.5 <sup>b, c</sup>		
Pulsed drain current		I <sub>DM</sub>	70	— A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		5.9		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.7 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	30		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		6.5		
	T <sub>C</sub> = 70 °C		4.2	W	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3 b, c		
	T <sub>A</sub> = 70 °C	1	1.9 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>sta</sub>	-55 to +150	°C	

#### THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	$t \le 10 \text{ s}$	R <sub>thJA</sub>	34	41	°C/W		
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	15	19	-0/w		

#### Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 80 °C/W

S-82661-Rev. A, 03-Nov-08

1

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static		•			•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050	-	31	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.4	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.2	-	2.4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zava anto veltogo dvoin ouvent	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10	μA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	А	
Drain actures on state resistance à	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	0.0032	0.0039	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.0045	0.0055		
Forward transconductance a	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	65	-	S	
Dynamic <sup>b</sup>		•			•		
Input capacitance	C <sub>iss</sub>		-	2730	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	540	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	205	-		
Total gate charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	42.5	65	nC	
			-	21.5	33		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	6.9	-		
Gate-drain charge	Q <sub>gd</sub>		-	7.1	-		
Gate resistance	Rg	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	30	50		
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	19	35		
Turn-off delay time	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong\text{10 A},\text{V}_\text{GEN}=\text{4.5 V},\text{R}_\text{g}=\text{1}~\Omega$	-	35	60		
Fall time	t <sub>f</sub>		-	15	30		
Turn-on delay time	t <sub>d(on)</sub>		-	12	24	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{\text{L}} = 1.5 \Omega$	-	9	18	-	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 10$ Å, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$	-	29	50		
Fall time	t <sub>f</sub>		-	9	18		
Drain-source body diode characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	5.9	٨	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	70	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A	-	0.74	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	28	55	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs,	-	21	42	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 \text{ °C}$	-	15	-		
Reverse recovery rise time	t <sub>b</sub>	1	-	13	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

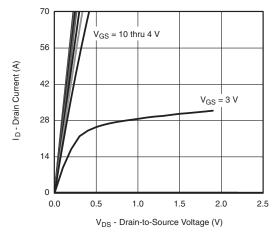
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Document Number: 68953

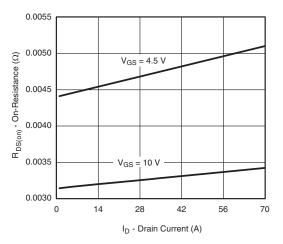


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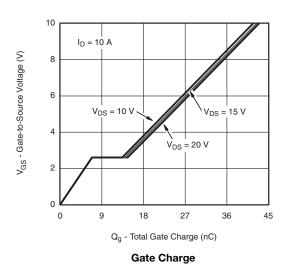
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

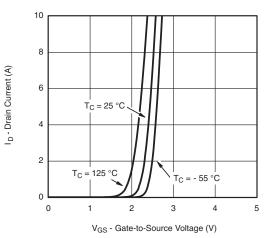


**Output Characteristics** 

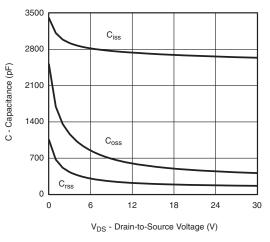


**On-Resistance vs. Drain Current and Gate Voltage** 

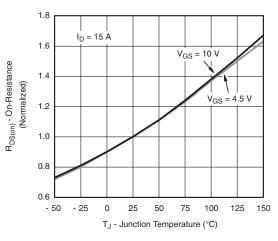




Transfer Characteristics







**On-Resistance vs. Junction Temperature** 

S-82661-Rev. A, 03-Nov-08

3

Document Number: 68953

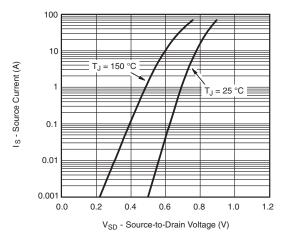
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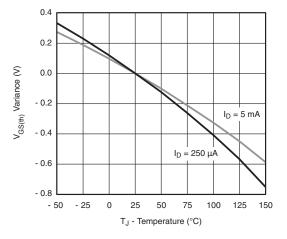
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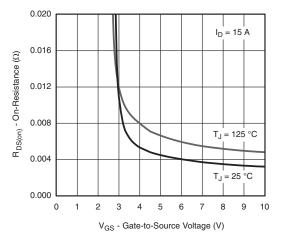
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



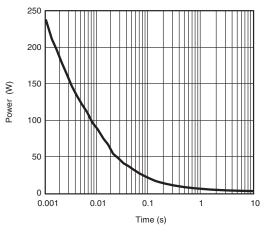
Source-Drain Diode Forward Voltage



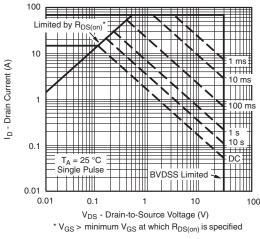




**On-Resistance vs. Gate-to-Source Voltage** 







Safe Operating Area, Junction-to-Ambient

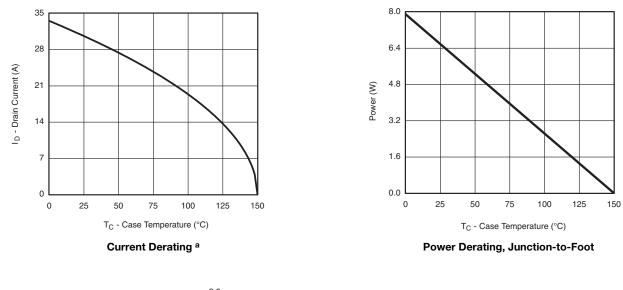
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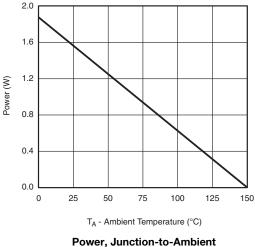
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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





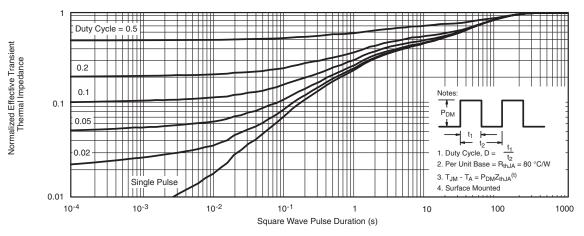
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

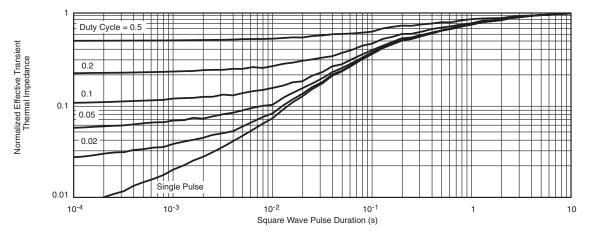


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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68953.

6



## Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

## **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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